

1770885

https://www.phoenixcontact.com/us/products/1770885

Please be informed that the data shown in this PDF document is generated from our online catalog. Please find the complete data in the user documentation. Our general terms of use for downloads are valid.



PCB terminal block, nominal current: 6 A, rated voltage (III/2): 160 V, nominal cross section: 0.5 mm², number of potentials: 2, number of rows: 1, number of positions per row: 2, product range: PTSM 0,5/..-H-THR, pitch: 2.5 mm, connection method: Push-in spring connection, mounting: THR soldering, conductor/PCB connection direction: 0 °, color: black, Pin layout: Linear pinning, Solder pin [P]: 2.1 mm, number of solder pins per potential: 2, type of packaging: 24 mm wide tane

Your advantages

- · Time saving push-in connection, tools not required
- Defined contact force ensures that contact remains stable over the long term
- · High current carrying capacity of 6 A in very compact dimensions
- · Designed for integration into the SMT soldering process

Commercial data

Item number	1770885
Packing unit	530 pc
Minimum order quantity	530 pc
Sales key	AA11
Product key	AAKCAA
Catalog page	Page 51 (C-1-2013)
GTIN	4046356459464
Weight per piece (including packing)	1.292 g
Weight per piece (excluding packing)	1.237 g
Customs tariff number	85369010
Country of origin	IN



1770885

https://www.phoenixcontact.com/us/products/1770885

Technical data

Product properties

Туре	Component suitable for through hole reflow
Product line	COMBICON Terminals XS
Product type	Printed circuit board terminal
Product family	PTSM 0,5/H-THR
Number of positions	2
Pitch	2.5 mm
Number of connections	2
Number of rows	1
Number of potentials	2
Pin layout	Linear pinning
Solder pins per potential	2

Electrical properties

Nominal current I _N	6 A
Nominal voltage U _N	160 V
Degree of pollution	3
Rated voltage (III/3)	63 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	200 V
Rated surge voltage (II/2)	2.5 kV

Connection data

Connection technology

Туре	Component suitable for through hole reflow
Nominal cross section	0.5 mm ²

Conductor connection

Sonductor connection	
Connection method	Push-in spring connection
Conductor cross section rigid	0.14 mm² 0.5 mm²
Conductor cross section flexible	0.2 mm ² 0.5 mm ² (up to 0.75 mm ² supported, with a stripping length of 7.5 mm and a rated insulation voltage of 32 V at III/2)
Conductor cross section AWG	26 20
Conductor cross section flexible, with ferrule without plastic sleeve	0.25 mm² 0.5 mm²
Conductor cross section, flexible, with ferrule, with plastic sleeve	0.25 mm ² 0.34 mm ² (possible from 0.14 mm ² , when using ferrule AI 0.14- 6 GY in combination with crimping pliers CRIMPFOX 10T-F)
Cylindrical gauge a x b / diameter	- / 1.2 mm
Stripping length	6 mm



1770885

https://www.phoenixcontact.com/us/products/1770885

Mounting

Mounting type	THR soldering
Pin layout	Linear pinning
Processing notes	
Process	Reflow/wave soldering
Moisture Sensitive Level	MSL 1
Classification temperature T _c	260 °C
Olassification temperature 1 _c	200 G

Material specifications

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	hot-dip tin-plated
Metal surface terminal point (top layer)	Tin (4 - 8 µm Sn)
Metal surface soldering area (top layer)	Tin (4 - 8 μm Sn)

Material data - housing

Color (Housing)	black (9005)
Insulating material	LCP
Insulating material group	Illa
CTI according to IEC 60112	175
Flammability rating according to UL 94	V0

Dimensions

Dimensional drawing	n n
Pitch	2.5 mm
Width [w]	5.5 mm
Height [h]	7.1 mm
Length [I]	10 mm
Installed height	5 mm
Solder pin length [P]	2.1 mm
Pin dimensions	0.3 x 0.8 mm
PCB design	
Pin spacing	5 mm
Hole diameter	1.2 mm



1770885

https://www.phoenixcontact.com/us/products/1770885

Mechanical tests

Specification	IEC 60998-2-2:2002-12
Result	Test passed
est for conductor damage and slackening	
Specification	IEC 60998-2-2:2002-12
Result	Test passed
ull-out test	
Specification	IEC 60998-2-2:2002-12
Conductor cross section/conductor type/tractive force	0.14 mm² / solid / > 10 N
setpoint/actual value	0.2 mm² / flexible / > 10 N
	0.5 mm² / solid / > 20 N
	0.75 mm² / flexible / > 30 N
lexion test	
Specification	IEC 60998-2-2:2002-12
Result	Test passed
sulation holder for crimp connections	
Result	Test passed
ctrical tests	
emperature-rise test	IEC 60998-2-1:2002-12
emperature-rise test Specification	
emperature-rise test Specification Requirement temperature-rise test	IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K
emperature-rise test Specification Requirement temperature-rise test	Increase in temperature ≤ 45 K
emperature-rise test Specification Requirement temperature-rise test esulation resistance Specification	Increase in temperature ≤ 45 K IEC 60998-1:2002-12
emperature-rise test Specification Requirement temperature-rise test	Increase in temperature ≤ 45 K
emperature-rise test Specification Requirement temperature-rise test sulation resistance Specification Insulation resistance, neighboring positions ir clearances and creepage distances	Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ
emperature-rise test Specification Requirement temperature-rise test sullation resistance Specification Insulation resistance, neighboring positions ir clearances and creepage distances Specification	Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04
emperature-rise test Specification Requirement temperature-rise test sulation resistance Specification Insulation resistance, neighboring positions ir clearances and creepage distances Specification Insulating material group	Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 IIIa
emperature-rise test Specification Requirement temperature-rise test sullation resistance Specification Insulation resistance, neighboring positions ir clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112)	Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 IIIa CTI ≥175 to <400
emperature-rise test Specification Requirement temperature-rise test sulation resistance Specification Insulation resistance, neighboring positions ir clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3)	Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 IIIa CTI ≥175 to <400 63 V
emperature-rise test Specification Requirement temperature-rise test sullation resistance Specification Insulation resistance, neighboring positions ir clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3)	Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 IIIa CTI ≥175 to <400 63 V 2.5 kV
emperature-rise test Specification Requirement temperature-rise test Issulation resistance Specification Insulation resistance, neighboring positions Ir clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3)	Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 IIIa CTI ≥175 to <400 63 V 2.5 kV 1.5 mm
emperature-rise test Specification Requirement temperature-rise test sulation resistance Specification Insulation resistance, neighboring positions ir clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3) minimum creepage distance (III/3)	Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 IIIa CTI ≥175 to <400 63 V 2.5 kV 1.5 mm 2 mm
emperature-rise test Specification Requirement temperature-rise test sulation resistance Specification Insulation resistance, neighboring positions ir clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3) minimum creepage distance (III/3) Rated insulation voltage (III/2)	Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 IIIa CTI ≥175 to <400 63 V 2.5 kV 1.5 mm 2 mm 160 V
emperature-rise test Specification Requirement temperature-rise test sulation resistance Specification Insulation resistance, neighboring positions ir clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3) minimum creepage distance (III/3) Rated insulation voltage (III/2) Rated surge voltage (III/2)	Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 IIIa CTI ≥175 to <400 63 V 2.5 kV 1.5 mm 2 mm 160 V 2.5 kV
emperature-rise test Specification Requirement temperature-rise test sulation resistance Specification Insulation resistance, neighboring positions ir clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3) minimum creepage distance (III/3) Rated insulation voltage (III/2)	Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 IIIa CTI ≥175 to <400 63 V 2.5 kV 1.5 mm 2 mm 160 V



1770885

https://www.phoenixcontact.com/us/products/1770885

Rated surge voltage (II/2)	2.5 kV
minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	2 mm

Environmental and real-life conditions

Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz 60.1 Hz)
Sweep speed	5g (60.1 Hz 150 Hz)
Test duration per axis	2.5 h

Glow-wire test

Specification	IEC 60998-1:2002-12
Temperature	850 °C
Time of exposure	5 s

Ambient conditions

Ambient temperature (operation)	-40 °C 100 °C (Depending on the current carrying capacity/derating curve)
Ambient temperature (storage/transport)	-40 °C 70 °C
Relative humidity (storage/transport)	30 % 70 %
Ambient temperature (assembly)	-5 °C 100 °C

Packaging specifications

Dimensional drawing	W. T. W. T. T. W. T. T. T. W. T.
Type of packaging	24 mm wide tape
[W] tape width	24 mm
[W2] coil overall dimension	30.4 mm
[A] coil diameter	330 mm
Outer packaging type	Transparent-Bag
ESD level	(D) electrostatically conductive
Specification	DIN EN 61340-5-1 (VDE 0300-5-1): 2008-07



1770885

https://www.phoenixcontact.com/us/products/1770885

Phoenix Contact 2024 © - all rights reserved https://www.phoenixcontact.com

Phoenix Contact USA 586 Fulling Mill Road Middletown, PA 17057, United States (+717) 944-1300 info@phoenixcon.com